# **NCE N-Channel Super Trench Power MOSFET**

### **Description**

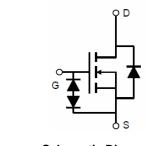
The NCEP4060EQ uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification. It is ESD protested.

#### **General Features**

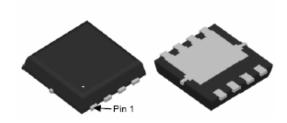
- $V_{DS}$  =40V, $I_D$  =60A  $R_{DS(ON)}$ =4.2mΩ (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =5.7mΩ (typical) @  $V_{GS}$ =4.5V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested
- ESD protection : HBM Class 2

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic Diagram



**Top View** 

**Bottom View** 

100% UIS TESTED! 100% ΔVds TESTED!

## **Package Marking and Ordering Information**

| Device Marking | Device     | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| NCEP4060EQ     | NCEP4060EQ | DFN3.3X3.3-8L  | -         | -          | -        |

### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

| Parameter  | Symbol                | Limit      | Unit         |
|--|-----------------------|------------|--------------|
| Drain-Source Voltage                             | V <sub>DS</sub>       | 40         | V            |
| Gate-Source Voltage                              | V <sub>G</sub> s      | ±20        | V            |
| Drain Current-Continuous (Silicon Limited)       | I <sub>D</sub>        | 60         | А            |
| Drain Current-Continuous(T <sub>C</sub> =100 °C) | I <sub>D</sub> (100℃) | 42.3       | Α            |
| Pulsed Drain Current (Package Limited)           | I <sub>DM</sub>       | 260        | Α            |
| Maximum Power Dissipation                        | P <sub>D</sub>        | 48         | W            |
| Derating factor                                  |                       | 0.38       | W/℃          |
| Single pulse avalanche energy (Note 5)           | Eas                   | 288        | mJ           |
| Operating Junction and Storage Temperature Range | $T_{J}, T_{STG}$      | -55 To 150 | $^{\circ}$ C |

#### **Thermal Characteristic**



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# Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

| Parameter                          | Parameter Symbol Condition      |  | Min | Тур  | Max  | Unit |  |
|------------------------------------|---------------------------------|--|-----|------|------|------|--|
| Off Characteristics                |                                 |  |     |      |      |      |  |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>               | V <sub>GS</sub> =0V I <sub>D</sub> =250μA 40 |     |      | -    | V    |  |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>                | V <sub>DS</sub> =40V,V <sub>GS</sub> =0V     |     | -    | 1    | μA   |  |
| Gate-Body Leakage Current          | I <sub>GSS</sub>                | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V    | -   | -    | ±10  | μA   |  |
| On Characteristics (Note 3)        |                                 |  |     |      |      |      |  |
| Gate Threshold Voltage             | $V_{GS(th)}$                    | $V_{DS}=V_{GS}$ , $I_{D}=250\mu A$           | 1.0 | 1.5  | 2.2  | V    |  |
| Drain-Source On-State Resistance   | -                               | V <sub>GS</sub> =10V, I <sub>D</sub> =20A    | -   | 4.2  | 4.5  | mΩ   |  |
| Dialii-Source Oil-State Resistance | R <sub>DS(ON)</sub>             | $V_{GS}$ =4.5V, $I_D$ =20A                   | -   | 5.7  | 6.2  | mΩ   |  |
| Forward Transconductance           | <b>g</b> FS                     | V <sub>DS</sub> =5V,I <sub>D</sub> =20A      |     | 40   | -    | S    |  |
| Dynamic Characteristics (Note4)    | Dynamic Characteristics (Note4) |  |     |      |      |      |  |
| Input Capacitance                  | C <sub>lss</sub>                | \/ -20\/\/ -0\/                              | -   | 2100 | 2600 | PF   |  |
| Output Capacitance                 | Coss                            | $V_{DS}$ =20V, $V_{GS}$ =0V,<br>F=1.0MHz     | -   | 639  | 800  | PF   |  |
| Reverse Transfer Capacitance       | C <sub>rss</sub>                | F=1.UIVID2                                   | -   | 23.6 | 29   | PF   |  |
| Switching Characteristics (Note 4) |                                 |  |     |      |      |      |  |
| Turn-on Delay Time                 | $t_{d(on)}$                     |  | -   | 7.5  | -    | nS   |  |
| Turn-on Rise Time                  | t <sub>r</sub>                  | $V_{DD} = 20V, I_D = 20A$                    | -   | 4    | -    | nS   |  |
| Turn-Off Delay Time                | $t_{d(off)}$                    | $V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$         | -   | 26   | -    | nS   |  |
| Turn-Off Fall Time                 | t <sub>f</sub>                  |  | -   | 3.3  | -    | nS   |  |
| Total Gate Charge                  | $Q_g$                           | \/ -20\/ L -20A                              | -   | 34.3 | 47   | nC   |  |
| Gate-Source Charge                 | $Q_{gs}$                        | $V_{DS}=20V,I_{D}=20A,$                      | -   | 7.1  |      | nC   |  |
| Gate-Drain Charge                  | $Q_{gd}$                        | V <sub>GS</sub> =10V                         | -   | 3.5  |      | nC   |  |
| Drain-Source Diode Characteristics | •                               |  | •   |      | •    |      |  |
| Diode Forward Voltage (Note 3)     | $V_{SD}$                        | V <sub>GS</sub> =0V,I <sub>S</sub> =60A      | -   |      | 1.2  | V    |  |
| Diode Forward Current (Note 2)     | Is                              |  | -   | -    | 60   | Α    |  |
| Reverse Recovery Time              | t <sub>rr</sub>                 | $T_J = 25^{\circ}C, I_F = I_S$               | -   | 19   | -    | nS   |  |
| Reverse Recovery Charge            | Qrr                             | $di/dt = 500A/\mu s^{(Note3)}$               | -   | 40   | -    | nC   |  |

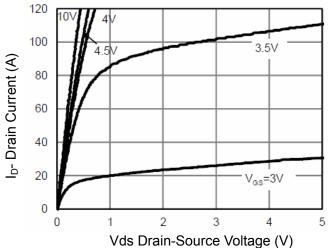
### Notes:

- ${\it 1. Repetitive Rating: Pulse width limited by maximum junction temperature.}\\$
- 2. Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V  $_{\text{DD}}$  =20V,V  $_{\text{G}}$  =10V,L=0.5mH,Rg=25 $\Omega$

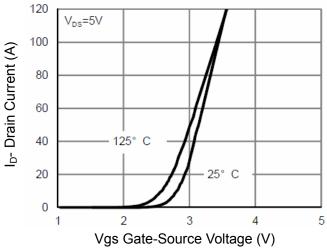
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### **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

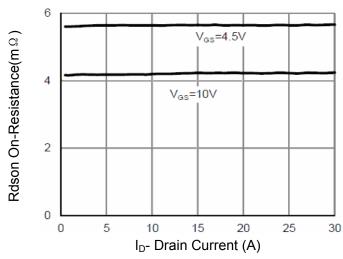
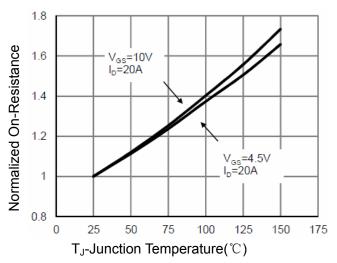


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 

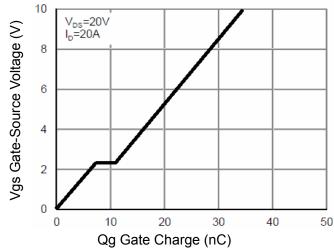


Figure 5 Gate Charge

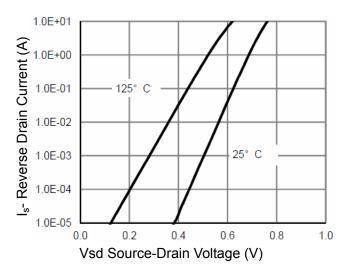
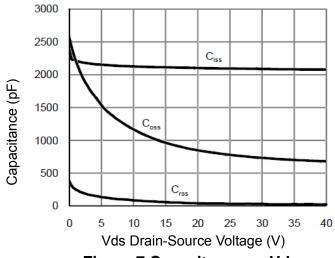


Figure 6 Source- Drain Diode Forward

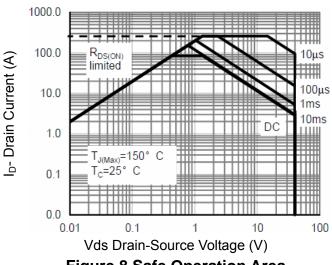


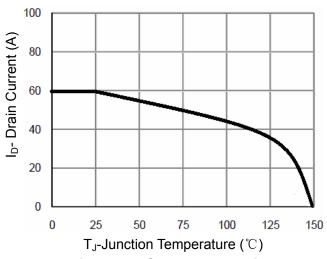
Power Dissipation (W) 80 60 40 20 0 0 25 50 75 125 100 150 T<sub>J</sub>-Junction Temperature(°C)

100

Figure 7 Capacitance vs Vds

Figure 9 Power De-rating





**Figure 8 Safe Operation Area** 

Figure 10 Current De-rating

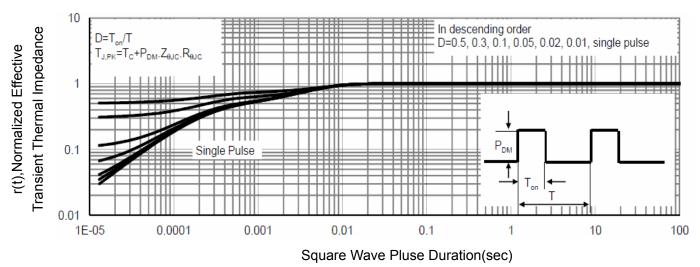
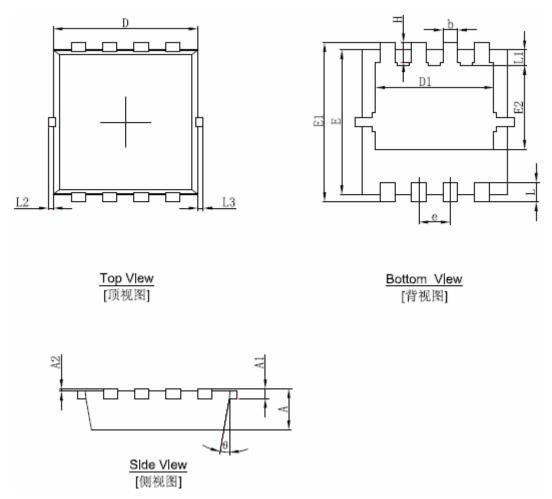


Figure 11 Normalized Maximum Transient Thermal Impedance

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# **DFN3.3X3.3-8L Package Information**



| Symbol | Dimensions | In Millimeters | Dimensions In Inches |       |  |
|--------|------------|----------------|----------------------|-------|--|
|        | Min.       | Max.           | Min.                 | Max.  |  |
| Α      | 0.650      | 0.850          | 0.026                | 0.033 |  |
| A1     | 0.152      | REF.           | 0.006 REF.           |       |  |
| A2     | 0~0        | 0.05           | 0~0.002              |       |  |
| D      | 2.900      | 3.100          | 0.114                | 0.122 |  |
| D1     | 2.300      | 2.600          | 0.091                | 0.102 |  |
| E      | 2.900      | 3.100          | 0.114                | 0.122 |  |
| E1     | 3.150      | 3.450          | 0.124                | 0.136 |  |
| E2     | 1.535      | 1.935          | 0.060                | 0.076 |  |
| b      | 0.200      | 0.400          | 0.008                | 0.016 |  |
| е      | 0.550      | 0.750          | 0.022                | 0.030 |  |
| L      | 0.300      | 0.500          | 0.012                | 0.020 |  |
| L1     | 0.180      | 0.480          | 0.007                | 0.019 |  |
| L2     | 0~0        | .100           | 0~0.004              |       |  |
| L3     | 0~0        | .100           | 0~0.004              |       |  |
| Н      | 0.315      | 0.515          | 0.012                | 0.020 |  |
| θ      | 9°         | 13°            | 9°                   | 13°   |  |



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